

机芯科技
HUTCHIP

HC3400

30V N-Channel MOSFET

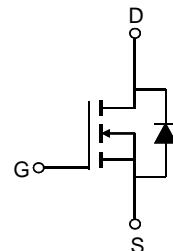
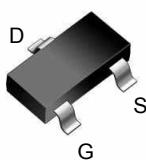
General Description

The HC3400 combines advanced trench MOSFET technology with a low resistance package to provide extremely low RDS(ON). This device is suitable for use as a load switch or in PWM applications.

Features

V_{DS}	30V
I_D (at $V_{GS}=10V$)	5.0A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	24mΩ(Typ)
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	30mΩ(Typ)

SOT23



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 12	V
Drain Current-Continuous	I_D (TC=25°C)	5.0	A
	I_D (TC=100°C)	3.3	A
Drain Current – Pulsed	I_{DM}	20	A
Maximum Power Dissipation	P_D	1.4	W
Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance junction-case	$R_{\theta JC}$		80	°C /W
Thermal Resistance junction-to-Ambient	$R_{\theta JA}$		125	°C /W

Electrical Characteristics (TJ=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=30V, V_{GS}=0V$			1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 12V, V_{DS}=0V$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	0.7	1.2	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=4.0A$		24	35	$m\Omega$
		$V_{GS}=4.5V, I_D=3.0A$		30	45	$m\Omega$
		$V_{GS}=2.5V, I_D=2.0A$		36	55	$m\Omega$
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{DS}=15V, V_{GS}=0V, F=1.0MHz$		510		pF
C_{oss}	Output Capacitance			50		pF
C_{rss}	Reverse Transfer Capacitance			38		pF
SWITCHING PARAMETERS						
$t_{d(on)}$	Turn-on Delay Time	$V_{GS}=10V$ $V_{DS}=15V$ $R_L=2.6\Omega$ $R_{GEN}=3\Omega$		3.0		nS
t_r	Turn-on Rise Time			2.8		nS
$t_{d(off)}$	Turn-Off Delay Time			25		nS
t_f	Turn-Off Fall Time			4		nS
Q_g	Total Gate Charge	$V_{DS}=15V, I_D=3A$ $V_{GS}=4.5V$		9.1		nC
Q_{gs}	Gate-Source Charge			2.1		nC
Q_{gd}	Gate-Drain Charge			2.8		nC
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_{SD}=1A$		0.72	1.3	V
R_g	Gate resistance	$V_{GS}=0V, V_{DS}=0V, F=1MHz$		2.0		Ω

Note:

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

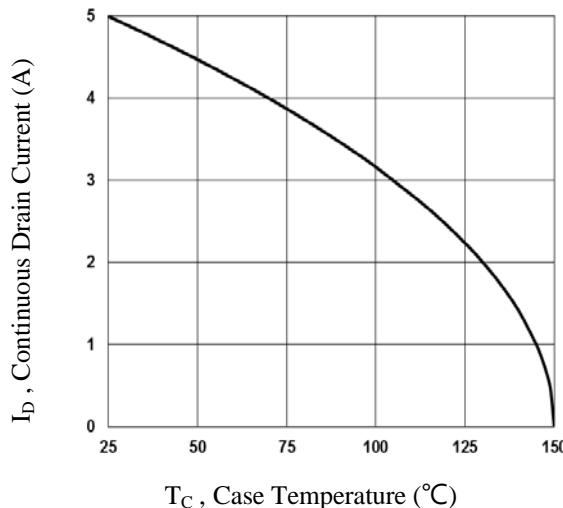
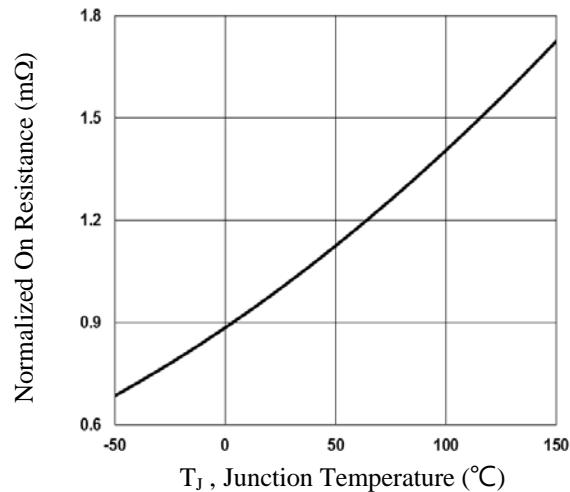
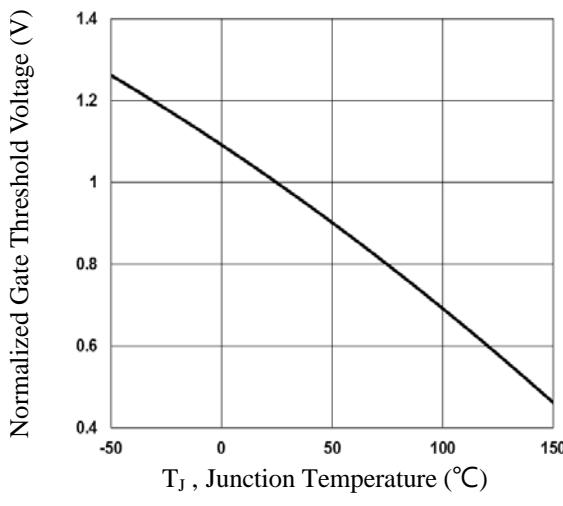
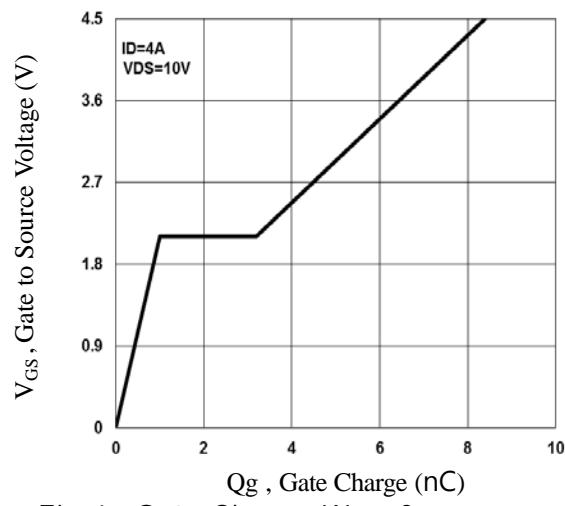
Fig.1 Continuous Drain Current vs. T_C Fig.2 Normalized RDS(ON) vs. T_J Fig.3 Normalized V_{th} vs. T_J 

Fig.4 Gate Charge Waveform

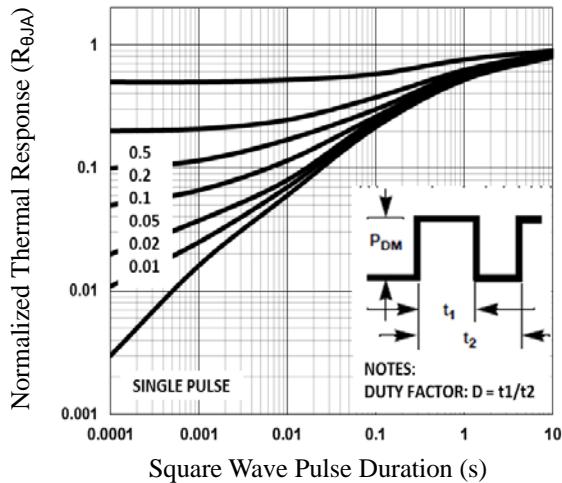


Fig.5 Normalized Transient Impedance

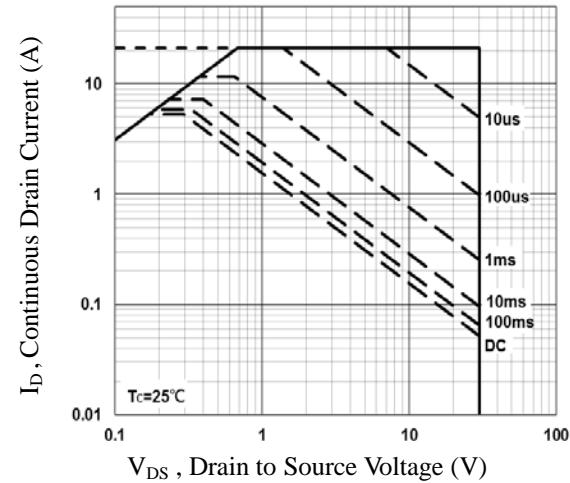


Fig.6 Maximum Safe Operation Area

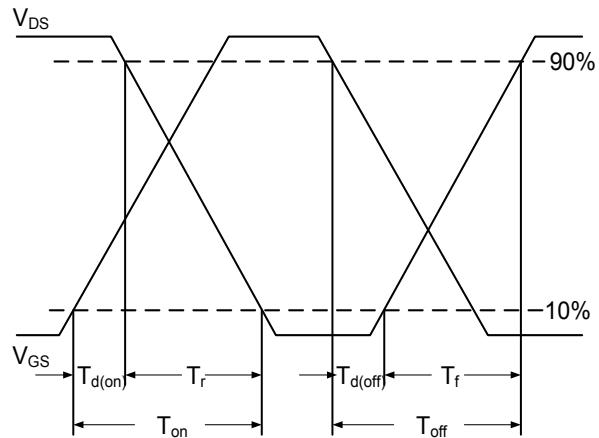
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig.7 Switching Time Waveform

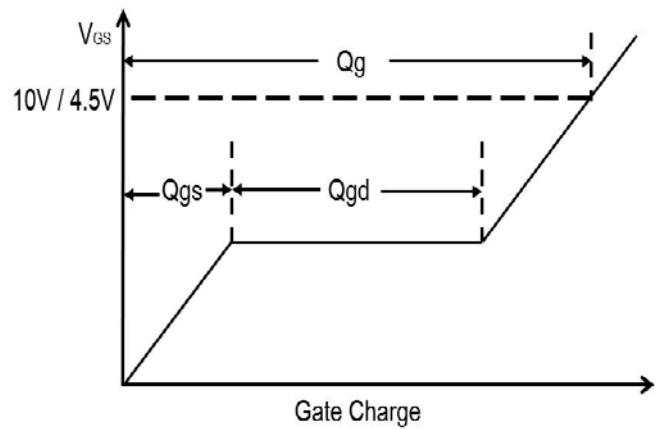
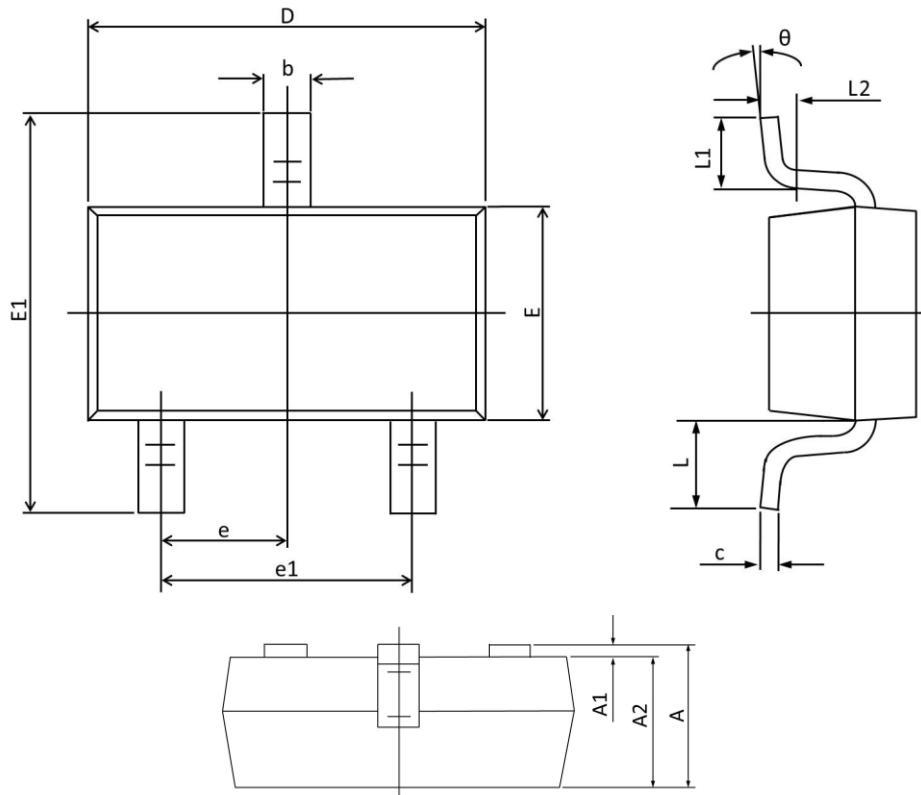


Fig.8 Gate Charge Waveform

SOT23 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Max	Min	Max	Min
A	1.150	0.900	0.045	0.035
A1	0.100	0.000	0.004	0.000
A2	1.050	0.900	0.041	0.035
b	0.500	0.300	0.020	0.012
c	0.150	0.080	0.006	0.003
D	3.000	2.800	0.118	0.110
E	1.400	1.200	0.055	0.047
E1	2.550	2.250	0.100	0.089
e	0.95 TYP.		0.037 TYP.	
e1	2.000	1.800	0.079	0.071
L	0.55 REF.		0.022 REF.	
L1	0.500	0.300	0.020	0.012
L2	0.25 TYP.		0.01 TYP.	
theta	8°	0°	8°	0°